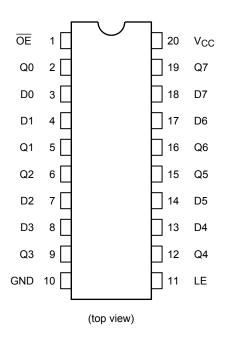
Pin Assignment

IEC Logic Symbol



OE (1) LE (11)	EN C1	
D0 (3) D1 (4) D2 (7) D3 (8) D4 (13) D5 (14) D6 (17) D7 (18)	1D P V	(2) Q0 (5) Q1 (6) Q2 (9) Q3 (12) Q4 (15) Q5 (16) Q6 (19) Q7

Truth Table

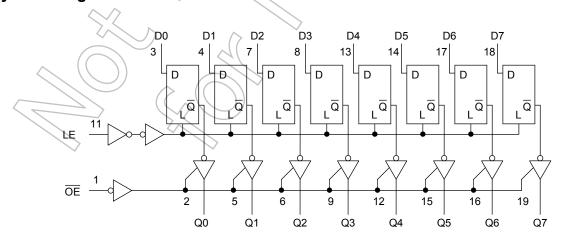
	Inputs	Output				
ŌE	LE	D	Q			
Н	Х	Х	Z			
L	L	Х	Qn			
L	Н	L	L			
L	Н	Н	Н			

X: Don't care

Z: High impedance

Qn: Q outputs are latched at the time when the LE input is taken to a low logic level.

System Diagram



Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Supply voltage range	V _{CC}	−0.5 to 7.0	V
DC input voltage	V _{IN}	-0.5 to V _{CC} + 0.5	V
DC output voltage	V _{OUT}	-0.5 to V _{CC} + 0.5	V
Input diode current	I _{IK}	±20	mA
Output diode current	lok	±50	
DC output current	lout	±50	mA
DC V _{CC} /ground current	Icc	±200)) mA
Power dissipation	P _D	500 (DIP) (Note 2)/180 (SOP/TSSOP)	mW
Storage temperature	T _{stg}	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of Ta = −40 to 65°C. From Ta = 65 to 85°C, a derating factor of −10 mW/°C should be applied up to 300 mW.

Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	VCC	2.0 to 5.5	V
Input voltage	// ŷ _{IN}	0 to V _{CC}	V
Output voltage	V _{OUT}	0 to V _{CC}	V
Operating temperature	T _{opr}	-40 to 85	°C
Input rise and fall time	dt/dV	0 to 100 ($V_{CC} = 3.3 \pm 0.3 \text{ V}$) 0 to 20 ($V_{CC} = 5 \pm 0.5 \text{ V}$)	ns/V

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V_{CC} or GND.

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2014-03-01



Electrical Characteristics

DC Characteristics

Characteristics	Symbol	Test Condition					;	Ta −40 to	Unit	
Characteristics	Symbol			V _{CC} (V)	Min	Тур.	Max	Min	Max	Offic
				2.0	1.50		1/	1.50	_	
High-level input voltage	High-level input	_		3.0	2.10	_		2.10	_	V
				5.5	3.85	1		3.85		
				2.0	>1	+0	0.50	_	0.50	
Low-level input voltage	V _{IL}		_	3.0	-		0.90	_	0.90	V
				5.5	-(7	1.65	_	1.65	
				2.0	1.9	2.0	_	1.9	_	
			I _{OH} = -50 μA	3.0	2.9	3.0	_	2.9	_	
High-level output	V _{OH}	V _{IN} = V _{IH} or V _{IL}		4.5	4.4	4.5	-	4.4	\rightarrow	V
voltage	VOH		I _{OH} = -4 mA	3.0	2.58	_	-6	2.48	> —	·
			I _{OH} = −24 mA	4.5	3.94	$-\Diamond$	(3.80) —	
			$I_{OH} = -75 \text{ mA}$ (Note)	5.5	_	1	X	3.85		
		V _{IN} = V _{IH} or V _{IL}		2.0	_	0.0	0.1	> _	0.1	V
			I _{OL} = 50 μA	3.0	_	0.0	0.1	_	0.1	
Low-level output	V _{OL}			4.5	_	(0.0)	0.1	_	0.1	
voltage	VOL.		I _{OL} = 12 mA	3.0		\mathcal{A}	0.36	_	0.44	V
			I _{OL} = 24 mA	4.5	-	/-	0.36	_	0.44	
			$I_{OL} = 75 \text{ mA}$ (Note)	5.5	_))—	1	_	1.65	
3-state output off-state current	I _{OZ}	V _{IN} = V _{IH} or V _{IL} V _{OUT} = V _{CC} or GND		5.5			±0.5	١	±5.0	μΑ
Input leakage current	I _{IN}	V _{IN} = V _{CC} or GND		5.5	<u> </u>	-	±0.1	1	±1.0	μΑ
Quiescent supply current	lec	$V_{IN} = V_{O}$	5.5	_	_	8.0	_	80.0	μΑ	

Note: This spec indicates the capability of driving 50 Ω transmission lines.

One output should be tested at a time for a 10 ms maximum duration.

Timing Requirements (input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Test Condition		Ta = 25°C	Ta = -40 to 85°C	Unit
		\Rightarrow	V _{CC} (V)	Limit	Limit	
Minimum pulse width	~ (\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \		3.3 ± 0.3	7.0	7.0	ns
(LE)	tw(H)	_	5.0 ± 0.5	5.0	5.0	115
Minimum set-up time			3.3 ± 0.3	6.0	6.0	ns
Willimani set-up time	ίς	_	5.0 ± 0.5	3.5	3.5	10
Minimum hold time	t .		3.3 ± 0.3	1.0	1.0	ns
Williman noid time	t _h	_	5.0 ± 0.5	1.0	1.0	115



AC Characteristics (C_L = 50 pF, R_L = 500 Ω , input: t_r = t_f = 3 ns)

Characteristics	Symbol Test Condition			a = 25°C		Ta = -40 to 85°C		Unit	
'	-,		V _{CC} (V)	Min	Тур.	Max	Min	Max	
Propagation delay time	t _{pLH}	_	3.3 ± 0.3	_	7.7	13.2	1.0	15.0	ns
(LE-Q)	t _{pHL}		5.0 ± 0.5	_	6.1	8.7	1.0	10.0	
Propagation delay time	t _{pLH}	_	3.3 ± 0.3	_	7.6	12.9	1.0	14.7	ns
(D-Q)	t _{pHL}		5.0 ± 0.5	_	5.8	8.3	1.0	9.5	
Output enable time	t _{pZL}		3.3 ± 0.3	₹\	7.6	12.9	1.0	14.7	ns
Output enable time	t _{pZH}	_	5.0 ± 0.5	->	6.1	8.7	1.0	10.0	115
Output disable time	t _{pLZ}	_	3.3 ± 0.3	-((7.0	11.0	1.0	12.5	ns
Output disable time	t _{pHZ}	_	5.0 ± 0.5		5.4	7.5	1.0	8.5	10
Input capacitance	C _{IN}	_		1(-/	5	10	4	10	pF
Output capacitance	C _{OUT}	_	6		10	- /	2/-//		pF
Power dissipation capacitance	C _{PD}		(Note)	(2)	38	_(() –	pF

Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

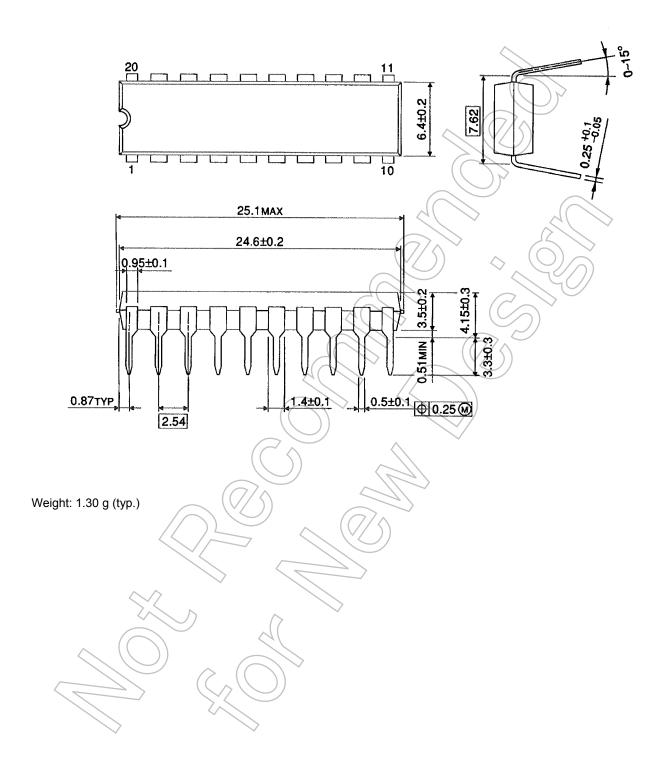
 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} \cdot I_{CC} / 8$ (per latch)

And the total CPD when n pcs. of latch operate can be gained by the following equation:

C_{PD} (total) = 26 + 12·n

Package Dimensions

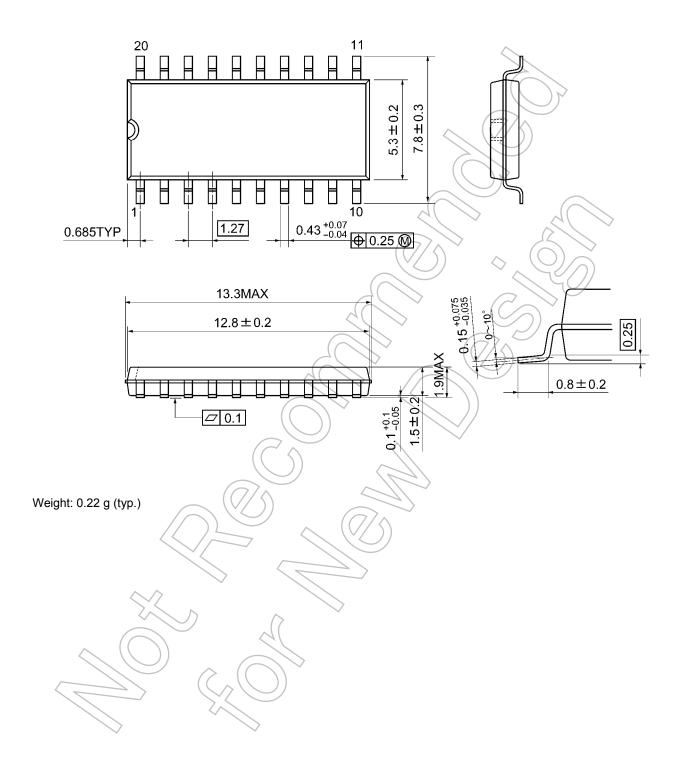
DIP20-P-300-2.54A Unit: mm





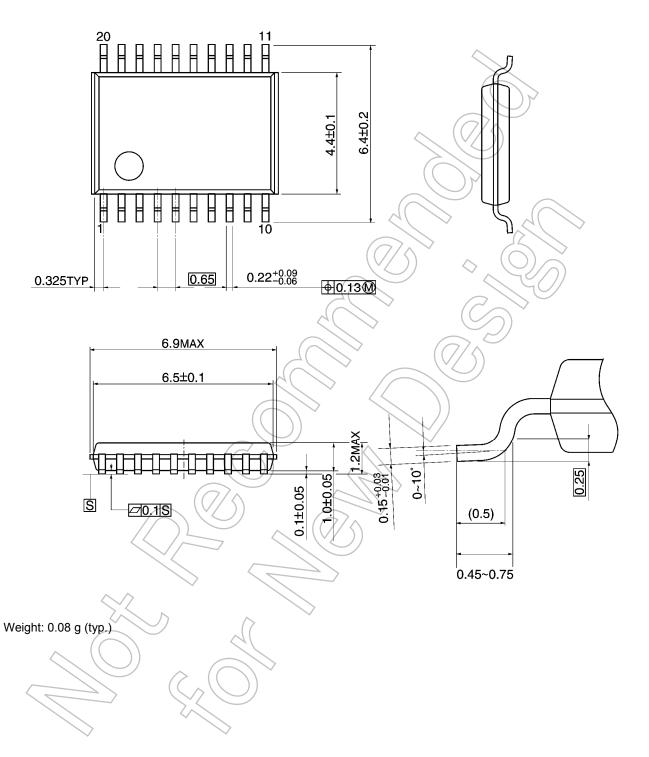
Package Dimensions

SOP20-P-300-1.27A Unit: mm



Package Dimensions

TSSOP20-P-0044-0.65A Unit: mm



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